Version : PRE.001 Issue Date : 2006/5/1 File Name : SP-DM11C-PRE.001.doc Total Pages: 23

8-bit Constant Current LED Driver

with Error Detection





8-bit Constant Current LED Driver with Error Detection

General Description

DM11C is a constant-current sink driver specifically designed for LED display applications. The device incorporates shift registers, data latches, and constant current circuitry on the silicon CMOS chip. The maximum output current value of all 8 channels is adjustable by a single external resistor. Its built-in open/short detection circuits help users detect LED failures. System retrieve the error messages to indicate which channel has failure by serial output data. The thermal shutdown function provides the over temperature protection.

Features

- Constant-current outputs: 5mA to 90mA adjustable by one external resistor
- Maximum output voltage: 17V
- Maximum clock frequency: 25MHz
- Built-in real-time LED open/short detection
- Fast detecting response: 0.1us (min.)
- Over temperature protection: thermal shutdown (junction temperature > 180° C)
- Package and pin assignment compatible to conventional LED drivers (ST2221A, DM114/5)
- Power supply voltage: 3.3V to 5.5V

Applications

- Indoor/Outdoor LED Video Display
- LED Variable Message Signs (VMS) System

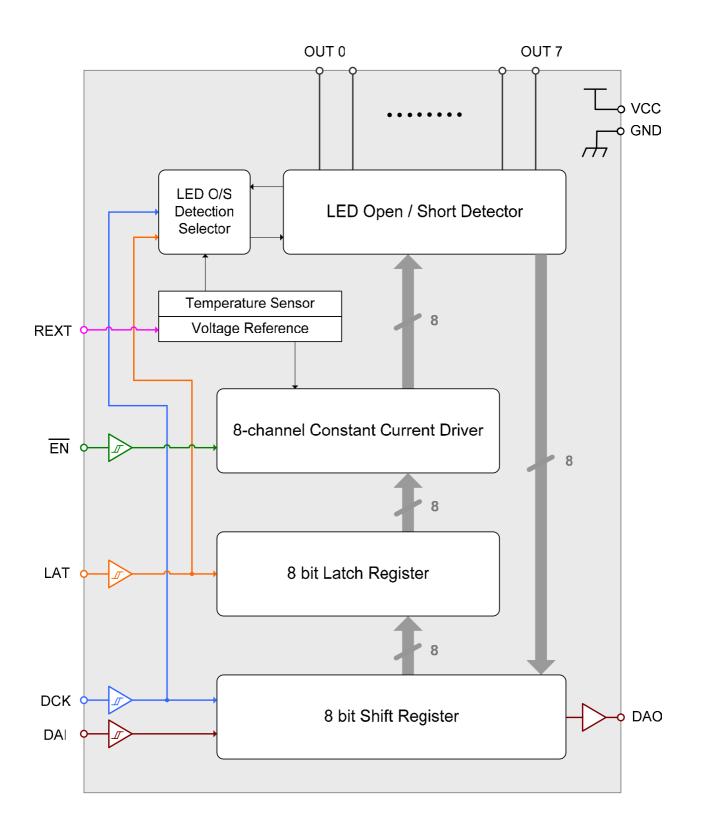
Package Types

• PDIP16, SOP16, SSOP16, or TSSOP16 (with thermal pad)

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Block Diagram

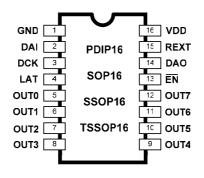


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Pin Connection



Pin Description

PIN No.	PIN NAME	FUNCTION
1	GND	Ground terminal.
2	DAI	Serial data input terminal.
3	DCK	Synchronous clock input terminal for serial data transfer. Data is sampled at the rising edge of DCK.
4	LAT	Input terminal of data strobe. Data on shift register goes through at the rising edge of LAT (edge trigger). Otherwise, data is latched.
5~12	OUT0~15	Sink constant-current outputs (open-drain).
13	EN	Output enable terminal: 'H' for all outputs are turned off , 'L' for all outputs are active.
14	DAO	Serial data output terminal.
15	REXT	External resistors connected between REXT and GND for output current value setting.
16	VCC	Supply voltage terminal.

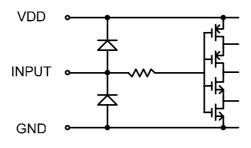
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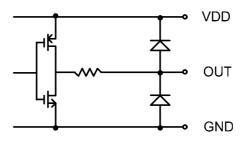


Equivalent Circuit of Inputs and Outputs

1. DCK, DAI, LAT, EN terminals



2. DAO terminals





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DM11C

Maximum Ratings (Ta=25°C, Tj(max) = 120°C)

CHARACTERISTIC	SYMBOL	RATING	UNIT		
Supply Voltage	VCC	-0.3 ~ 7.0	V		
Input Voltage	VIN	-0.3 ~ VCC+0.3	V		
Output Current	IOUT	100	mA		
Output Voltage	VOUT	-0.3 ~ 17	V		
Input Clock Frequency	FDCK	25	MHz		
GND Terminal Current	IGND	800	mA		
		1.12 (PDIP16 : Ta=25°C)			
Power Dissipation		0.86 (SOP16 : Ta=25°C)	10/		
(4 layer PCB)	PD	0.82 (SSOP16 : Ta=25°C)	W		
		2.5 (TSSOP16 : Ta=25°C)			
		85.0 (PDIP16)			
Thermal Desistance		110.9 (SOP16)	0000		
Thermal Resistance	Rth(j-a)	115.9 (SSOP16)	°C/W		
		38 (TSSOP16)			
Operating Temperature	Тор	-40 ~ 85	°C		
Storage Temperature	Tstg	-55 ~ 150	°C		

Recommended Operating Condition

CHARACTERISTIC	SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT
Supply Voltage	VCC		3.3	5.0	5.5	V
Output Voltage	VOUT	OUT Driver On ^{*1}			0.5VCC	V
Output Voltage	VOUT	Driver Off ^{*2}			17	V
	IO	OUTn	5		90	
Output Current	IOH	VOH = VCC - 0.2 V			+1.5	mA
	IOL	VOL = 0.2 V			-1.5	
Input Voltago	VIH	VCC = 3.3 V ~ 5.5V	0.8VCC		VCC	V
Input Voltage	VIL	VCC = 3.3 V ~ 5.5V	0.0		0.2VCC	
Input Clock Frequency	FDCK	Single Chip Operation			25	MHz
LAT Pulse Width	tw LAT		TBD			
DCK Pulse Width	tw DCK		TBD			
EN Pulse Width	tw EN		TBD			
Set-up Time for DAI	tsetup(D)		TBD			
Hold Time for DAI	thold(D)	VCC = 5.0V	TBD			ns
Set-up Time for LAT	tsetup(L)		TBD			
Hold Time for LAT	thold(L)		TBD			
Set-up Time for Open/Short	tsetup(OS)		TBD			
Open/Short Detection Response	tdet		TBD			

 $^{^{*1}}$ Notice that the power dissipation is limited to its package and ambient temperature. *2 The driver output voltage including any overshoot stress has to be compliant with the maximum voltage (17V).



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Electrical Characteristics (VCC = 5.0 V, Ta = 25°C unless otherwise noted)

CHARACTERISTIC	SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT	
Input Voltage "H" Level	VIH	CMOS logic level	0.8VCC		VCC		
Input Voltage "L" Level	VIL	CMOS logic level	GND		0.2VCC	V	
Output Leakage Current	IOL	VOH = 17 V			±1.0	uA	
	VOL	IOL = 1.5 mA			0.2	V	
Output Voltage (S-OUT)	VOH	IOH= 1.5 mA	VCC-0.2			V	
Output Current Skew (Channel-to-Channel) ^{*1}	IOL1	VOUT = 1.0 V			±3	%	
Output Current Skew (Chip-to-Chip) ^{*2}	IOL2	Rrext = 2.2 K Ω	TBD	TBD	TBD	mA	
Output Voltage Regulation	% / VOUT	Rrext = 2.2 KΩ VOUT = 1 V ~ 3 V		±0.1	±0.5	% / V	
Supply Voltage Regulation	% / VCC	Rrext = 2.2 K Ω	_	±1	±4		
LED Open Detection Threshold	V(od)			0.3			
LED Short Detection Threshold	V(sd)	all outputs turn on		0.5VCC		V	
Thermal Shutdown Threshold	T(sht)	junction temperature		180		°C	
	I _{DD(off)}	power on all pins are open unless VCC and GND		2.0			
	IDD(off)	input signal is static Rrext = 2.9 KΩ all outputs turn off		2.8			
Supply Current ^{*3}	I _{DD(on)}	input signal is static Rrext = 2.9 KΩ all outputs turn on		3.5		mA	
	I _{DD(on)}	input signal is static Rrext = 560 Ω all outputs turn off	_	7.2			
	I _{DD(on)}	input signal is static Rrext = 560 Ω all outputs turn on		8.4			

*3 IO excluded.

^{*1} Channel-to-channel skew is defined as the ratio between (any Iout – average Iout) and average Iout, where average Iout = (Imax + Imin) / 2. *² Chip-to-Chip skew is defined as the range into which any output current of any IC falls.

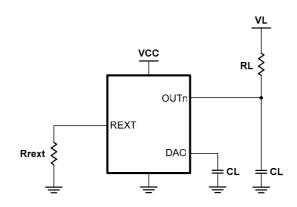


Switching Characteristics (VCC = 5.0V, Ta = 25°C unless otherwise noted)

CHARACTERISTIC		SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT
Propagation Delay	EN-to-OUT7				TBD		
	LAT-to-OUT7	tpLH	VIH = VCC		TBD		
('L to 'H')	DCK-to-DAO		VIL = GND		TBD		
Propagation Delay ('H' to 'L')	EN-to-OUT7		Rrext = 2.2 KΩ		TBD		
	LAT-to-OUT7	tpHL			TBD		ns
	DCK-to-DAO		VL = 5.0 V		TBD		
Output Current Rise Time		tor	RL = 180 Ω		TBD		
Output Current Fall Time		tof	CL = 13 pF		TBD		
Output Delay Time	e (OUT(n)-to-OUT(n+1))	tod			TBD		

Switching Characteristics (VCC = 3.3V, Ta = 25°C unless otherwise noted)

CHARACTERISTIC		SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT
Propagation Delay	EN-to-OUT7				TBD		
	LAT-to-OUT7	tpLH	VIH = VCC		TBD		
('L to 'H')	DCK-to-DAO		VIL = GND		TBD		
Brongastion Dolov	EN-to-OUT7		Rrext = 2.2 KΩ		TBD		
Propagation Delay	LAT-to-OUT7	tpHL			TBD		ns
('H' to 'L')	DCK-to-DAO		VL = 5.0 V		TBD		
Output Current Rise Time		tor	RL = 180 Ω		TBD		
Output Current Fall Time		tof	CL = 13 pF		TBD		
Output Delay Time	e (OUT _(n) -to-OUT _(n+1))	tod			TBD		



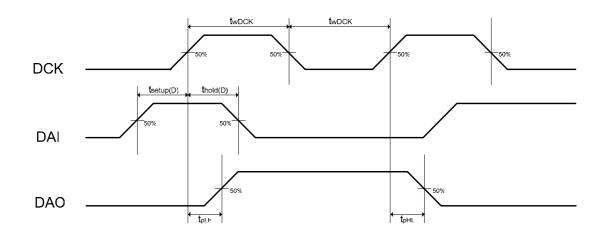
Switching Characteristics Test Circuit

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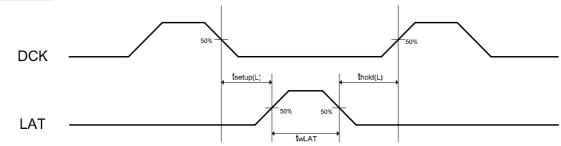


Timing Diagram

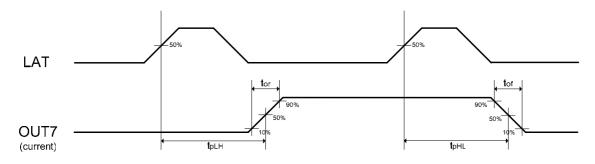
1. DCK-DAI, DAO



2. DCK-LAT



3. LAT-OUT7

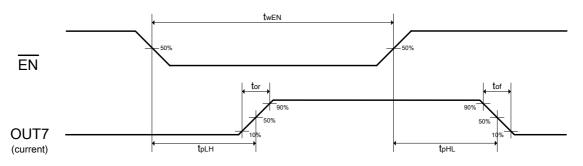


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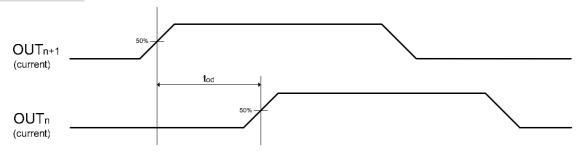
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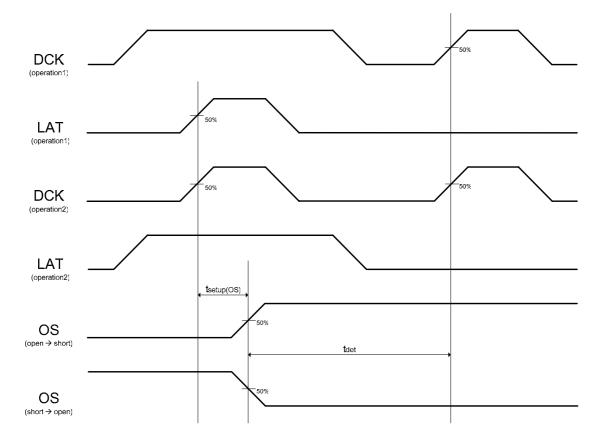
4. EN-OUT7



5. OUTn+1-OUTn



6. OS-LAT, DCK (EN='L')



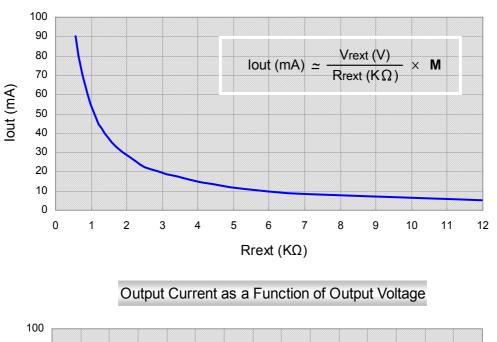
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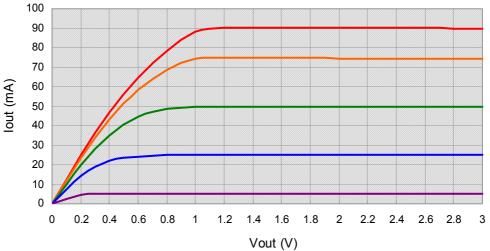
Constant-Current Output

Constant-current value of each output channel is set by an external resistor connected between the REXT pin and GND. Varying the resistor value can adjust the current scale ranging from 5mA to 90mA. The reference voltage of REXT terminal (Vrext) is approximately 0.6V. The output current value is calculated roughly by the following equation:

lout(mA)	5	10	20	30	40	50	60	70	80	90
М	99.7	98.1	96.0	94.2	92.5	90.8	89.1	87.1	85.1	84.4



Output Current as a Function of Rrext value

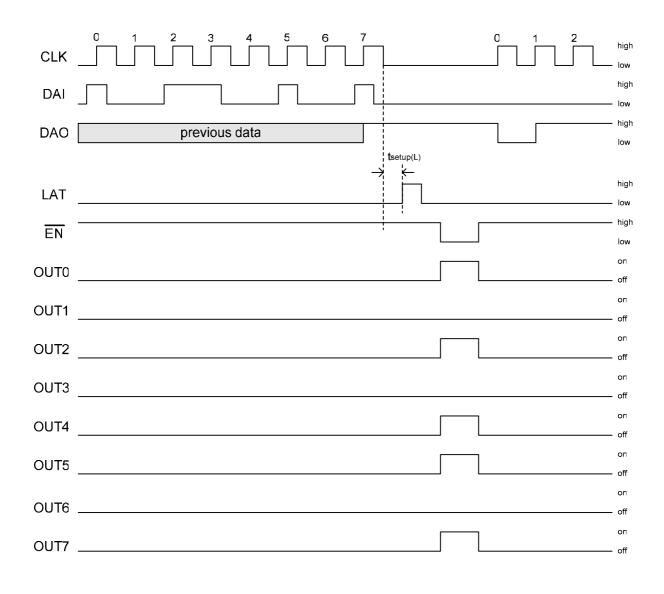


In order to obtain a good performance of constant-current output, a suitable output voltage is necessary. Users can get related information about the minimum output voltage above.



Serial Data Interface

The serial-in data (DAI) will be clocked into 8 bit shift register synchronized on the rising edge of the clock (DCK). The data '1' represents the corresponding current output 'ON', while the data '0' stands for 'OFF'. The data will be transferred into the 8 bit latch synchronized on the rising edge (edge trigger) of the strobe signal (LAT); otherwise, the data will be held. The latch pulse should be sent after the falling edge of the last clock within a frame data. The trigger timing of the serial-out data (DAO) will be shifted out on synchronization to the rising edge of the clock. All outputs are turned off while enable terminal (EN) is kept at high level. And they are active when EN shifts to low.



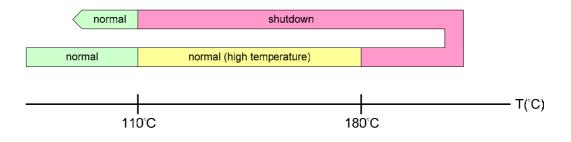
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Thermal Shutdown

During operation, when the junction temperature of the IC will reach approximately above 180° C, it will cause the driver to shutdown all the outputs. Basically, the IC will cool down and return to the safe operating temperature which is approximately below 110° C. DM11C will restart all the outputs at the same time. Operation in the thermal situation for a long time may cause chip damage permanently.



Relations between Thermal Shutdown and Junction Temperature

LED Open/Short Detection

The result of open/short detection of DM11C could be retrieved from serial-out (DAO) data. It will be identified as a LED open failure when the output is turned on but the output voltage is below 0.3V. And then it will be identified as a LED short failure when the output is turned on but the output voltage is above 1/2 VCC.

To set up with the following conditions: (1) the image data written in shift register corresponding to particular output channel is '1'; (2) the output enable terminal is activated (EN='L'); (3) the rising edge of the latch signal (LAT), DM11C will execute LED open/short detection then renews the results within the corresponding shift register.

By using the error message retrieved from serial-out data, system can recognize the status of every LED driven by each channel. For either LED open or short detection, the original image data is written to '1' but '0' is retrieved then a LED failure has occurred. If the image data is written to '0' or the output enable terminal is inactive (EN='H'), it will not execute any detection process for the corresponding channel. Therefore, system still retrieves the original image data.



Real-time monitor

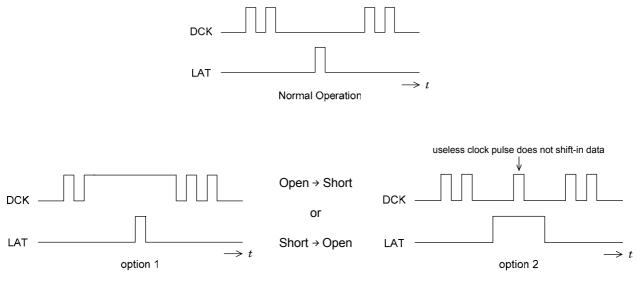
With the above operating principle, system could continuously retrieve LED status from serial-out then compare with the last frame data one by one. Once there is any discrepancy $('1' \rightarrow '0')$, we can locate which channel is abnormal precisely. Since the process is ongoing and without shifting between image mode and detection mode, it does not interrupt the image data flow and the output display. The "real-time monitor" method is suitable for LED Variable Message Signs (VMS) system.

Clocks calculation

For large LED display applications, "real-time monitor" could be a heavy loading for system because it needs to compare the retrieved information with a lot of frame data. Therefore, to write the image data of all channels to '1', all failure status will be identified when there will be any '0' retrieved. By calculating the numbers of clock pulses, the locations of abnormal channel could be pointed out easily. The "clocks calculation" method helps to minimize the loading and memory resources of system.

Selection of Open/Short Detection

The default detection type provided by DM11C is LED **open** detection after power-on. Users could switch LED open to short detection (or short to open detection) by following timing sequence. There are two alternative options could be selected. The option 1 shows triggering latch pulse when the last clock of the frame data kept at high level. The option 2 shows sending one useless clock pulse which will not shift-in data while the latch signal is kept at high level.



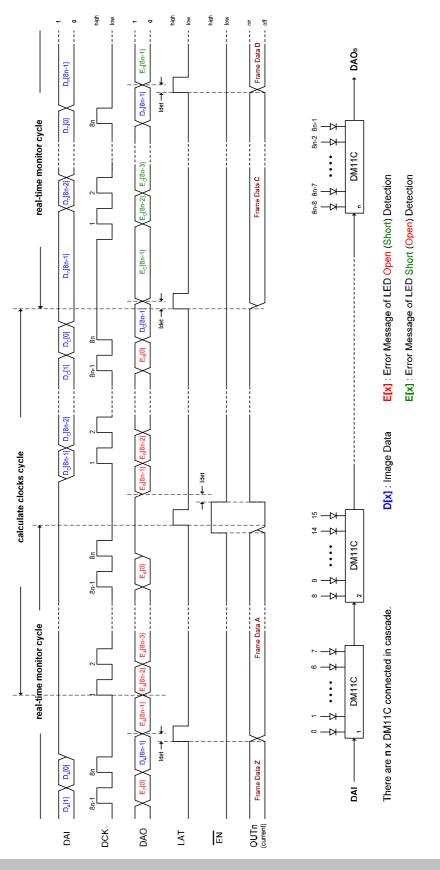
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Timing Diagram of LED Open/Short Detection

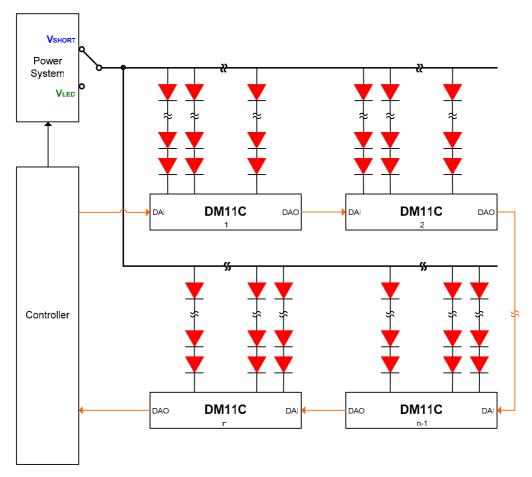


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Threshold of Short Detection

The default threshold voltage for LED short detection of DM11C is 1/2 VCC. One could change the default voltage by switching or setting a new voltage of VLED during short detection is going on. Please see the example below for reference:



Example for shifting the threshold of LED short detection

Note that the **V**_{SHORT} should be satisfied with the following inequality:

$$\frac{1}{2}VCC < V_{SHORT} < \frac{1}{2}VCC + V_{F(LED \text{ forward voltage})} \times N_{(Numbers of LED \text{ in a string})}$$

The new threshold voltage of short detection will be equivalent to:

$$\frac{1}{2}$$
 VCC + (V_{LED} - V_{SHORT})

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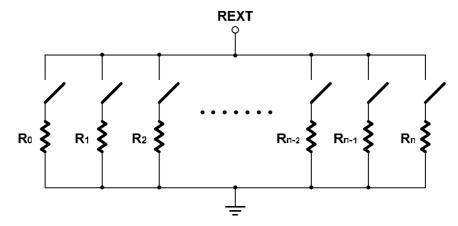


Outputs Delay

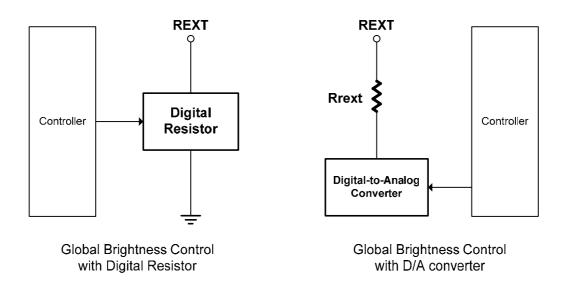
Large in-rush currents will occur when the system activates all the outputs at once. To reduce this effect, DM11C is designed to have a constant unit of delay (around 1.5ns) between every output. The delay for every output goes like this: there is no delay for OUT7, 1 unit of delay for OUT6, 2 units of delay for OUT5 and so on.

Global Brightness Control

DM11C has no built-in global brightness control feature. In order to obtain a lower resolution of global brightness control effect, two methods could be utilized. One is providing PWM signal synchronized on latch pulse to modulate the output enable terminal ($\overline{\text{EN}}$ pin). The other is to adjust the Rrext value or voltage drop across the external resistor. Please see the reference circuit below:



Global Brightness Control with Resistor Ladder



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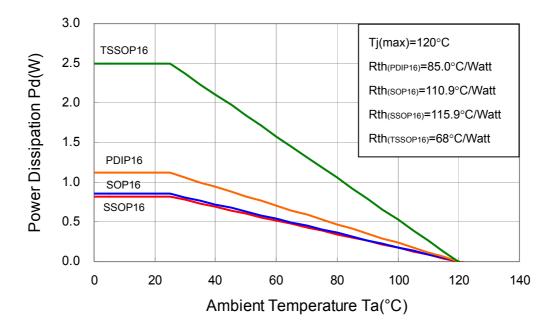


Power Dissipation

Notice that the power dissipation of a semiconductor chip is limited to its package and ambient temperature, in which the device requires the maximum output current calculated for given operating conditions. The maximum allowable power consumption can be calculated by the following equation:

 $Pd(max)(Watt) = \frac{Tj(junction\ temperature)(max)(\ \C) - Ta(ambient\ temperature)(\ \C)}{Rth(junction-to-air\ thermal\ resistance)(\ \C/Watt)}$

The relationship between power dissipation and operating temperature can be refer to the figure below:



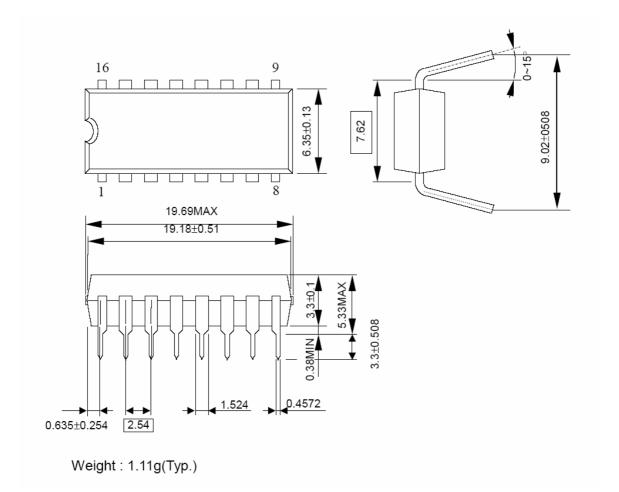
The power consumption of IC can be determined by the following equation and should be less than the maximum allowable power dissipation:

 $Pd(W) = Vcc(V) \times Idd(A) + Vout0 \times Iout0 \times Duty0 + \dots + Vout7 \times Iout7 \times Duty7 \le Pd(max)(W)$



PDIP16

Unit: mm



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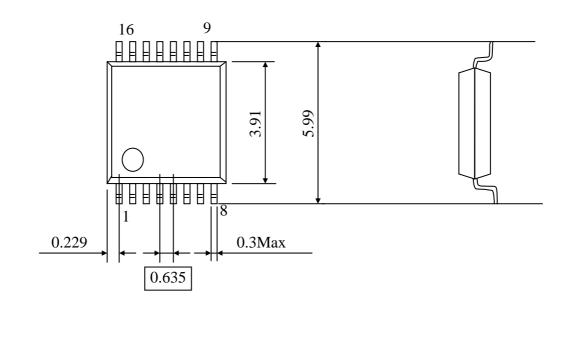
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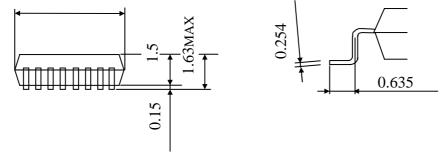


SSOP16

Unit: mm

DM11C





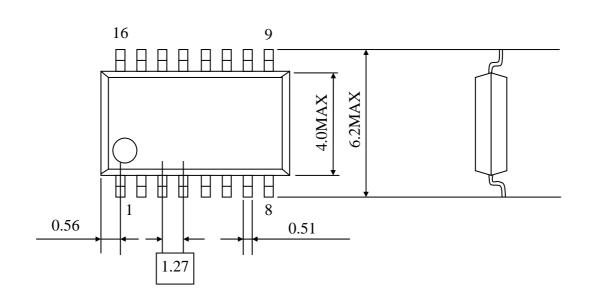
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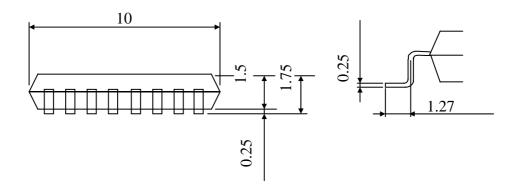


SOP16

Unit: mm

DM11C





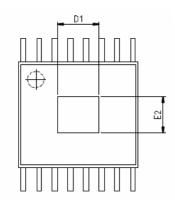
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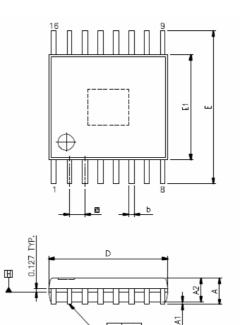


TSSOP16 (exposed pad)

Unit: mm

DM11C





△ 0.05





SYMBOLS	MIN.	NOM.	MAX.			
A	_	_	1.20			
A1	0.00	-	0.15			
A2	0.80	1.00	1.05			
ъ	0.19	-	0.30			
D	4.90	5.00	5.10			
D1	1.70	-	-			
E2	1.50	-	-			
E1	4.30	4.40	4.50			
E	6.40 BSC					
e		0.65 BSC				
L1	1.00 REF					
L	D.45	0.60	0.75			
S	0.20	_	_			
8	0.	_	8			

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The products listed herein are designed for ordinary electronic applications, such as electrical appliances, audio-visual equipment, communications devices and so on. Hence, it is advisable that the devices should not be used in medical instruments, surgical implants, aerospace machinery, nuclear power control systems, disaster/crime-prevention equipment and the like. Misusing those products may directly or indirectly endanger human life, or cause injury and property loss.

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